



(0.635 mm) .025"

**MEC6-DV SERIES** 

# **VERTICAL MICRO EDGE CARD SO**

#### **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?MEC6-DV

Insulator Material: Black LCP

Contact Material: Phosphor Bronze

Plating:
Au or Sn over
50 μ" (1.27 μm) Ni
Operating Temp Range:
-55 °C to +125 °C
-55 °C to +125 °C

Insertion Depth:

(4.22 mm) .166" to (5.66 mm) .223" Current Rating:

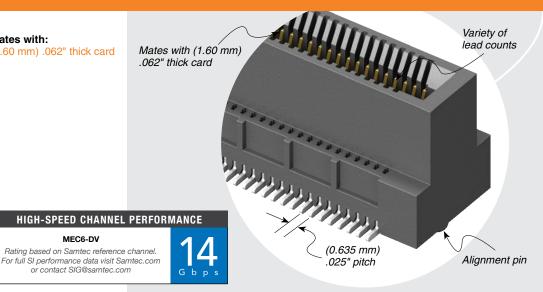
2.4 A per pin (2 pins powered) Voltage Rating:

**RoHS Compliant:** 

Mates with:

1.60 mm) .062" thick card

MEC6-DV



#### **PROCESSING**

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (10-50) (0.15 mm) .006" max (60-70)\*

(.004" stencil solution may be available: contact IPG@samtec.com)

### RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



#### **ALSO AVAILABLE** (MOQ Required)

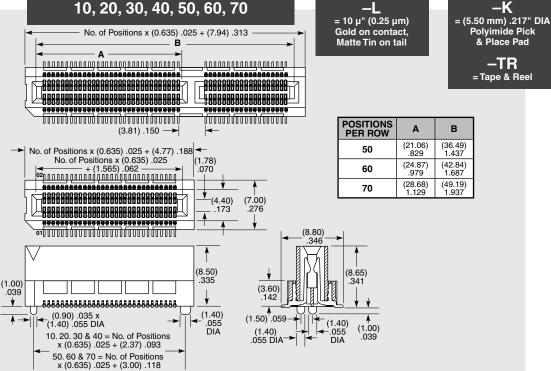
- Locking Clip (Manual placement required)
- · Other platings Contact Samtec.

## Notes:

While optimized for 50  $\Omega$  applications, this connector with alternative signal/ground patterns may also perform well in certain 75 Ω applications. Contact Samtec for further information.

Some sizes, styles and options are non-standard, non-returnable.





Due to technical progress, all designs, specifications and components are subject to change without notice